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STFH24N60M2

N-channel 600 V, 0.168 Ω typ., 18 A MDmesh[™] M2 Power MOSFET in a TO-220FP wide creepage package

Datasheet - production data

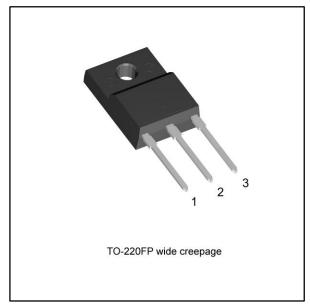
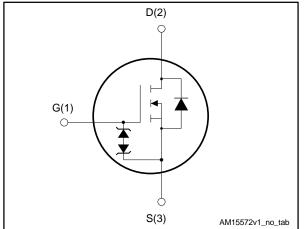


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max	Iв
STFH24N60M2	650 V	0.19 Ω	18 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected
- Wide creepage distance of 4.25 mm between the pins

Applications

- Switching applications
- LLC converters, resonant converters

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

The TO-220FP wide creepage package provides increased surface insulation for Power MOSFETs to prevent failure due to arcing, which can occur in polluted environments.

Table 1: Device summary

Order code	Marking	Package	Packing
STFH24N60M2	24N60M2	TO-220FP wide creepage	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at T _C = 25 °C	18 ⁽¹⁾	А
ΙD	Drain current (continuous) at T _c = 100 °C	12 ⁽¹⁾	А
I _{DM} ⁽²⁾	Drain current (pulsed)	72 ⁽¹⁾	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	30	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; TC = 25 °C)	2500	V
T _{stg}	Storage temperature range	55 to 150	℃
Tj	Operating junction temperature range	- 55 to 150	C

Notes:

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{(3)}I_{SD} \le 18$ A, di/dt ≤ 400 A/µs; V_DSpeak < V_(BR)DSS, V_DD = 400 V. $^{(4)}V_{DS} \le 480$ V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	4.2	°C/W
Rthj-amb	Thermal resistance junction-ambient max	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax})$	3.5	А
Eas	Single pulse avalanche energy (starting T _j =25 °C, I _D = I _{AR} ; V _{DD} =50 V)	180	mJ



2 Electrical characteristics

(T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 1 \text{ mA}$	600			V
		$V_{GS} = 0, V_{DS} = 600 V$			1	μA
IDSS	Zero gate voltage drain current	$V_{GS} = 0,$ $V_{DS} = 600 V,$ $T_{C}=125 \ ^{\circ}C^{(1)}$			100	μA
I _{GSS}	Gate-body leakage current	$V_{DS}=0, V_{GS}=\pm 25 \text{ V}$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$		0.168	0.190	Ω

Table 5: On /off states

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1060	-	pF
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	55	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.2	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	258	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	7	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 18 A,	-	29	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	6	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	12	-	nC

Table 6: Dynamic

Notes:

⁽¹⁾Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDSincreases from 0 to 80% VDSS.



Electrical characteristics

-	Table 7: Switching times						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 9 \text{ A},$	-	14	-	ns	
tr	Rise time	$R_{G} = 4.7 \ \Omega, \ V_{GS} = 10 \ V$	-	9	-	ns	
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times" and	-	60	-	ns	
t _f	Fall time	Figure 19: "Switching time waveform")	-	15	-	ns	

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd ⁽¹⁾	Source-drain current		-		18	А
I _{SDM} ⁽¹⁾⁽²⁾	Source-drain current (pulsed)		-		72	А
Vsd ⁽³⁾	Forward on voltage	$I_{SD} = 18 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 18 A, di/dt = 100 A/µs	-	332		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 V$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	4		μC
I _{RRM}	Reverse recovery current		-	24		А
trr	Reverse recovery time	I _{SD} = 18 A, di/dt = 100 A/µs	-	450		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit for inductive load switching and diode	-	5.5		μC
Irrm	Reverse recovery current	recovery times")	-	25		А

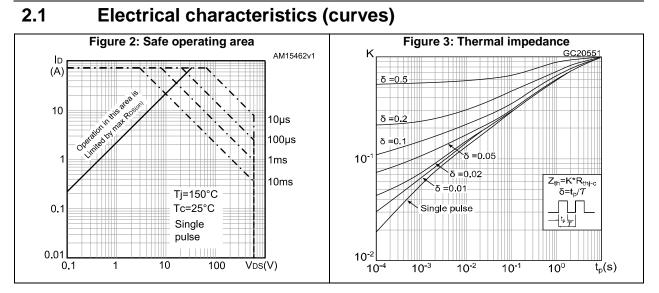
Notes:

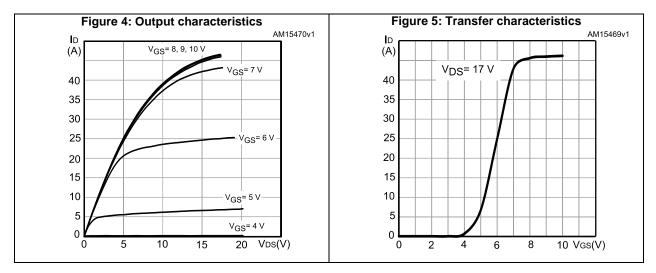
 $^{(1)}\mbox{The}$ value is rated according to $R_{\mbox{thj-case}}$ and limited by package.

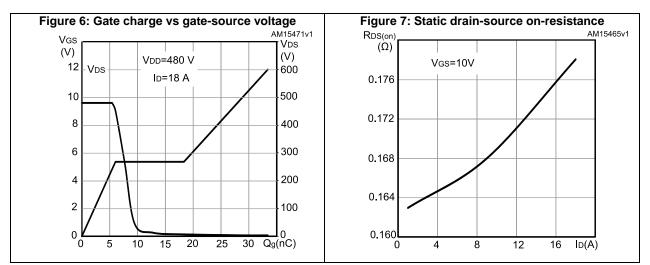
 $^{(2)}\mbox{Pulse}$ width limited by safe operating area

 $^{(3)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%









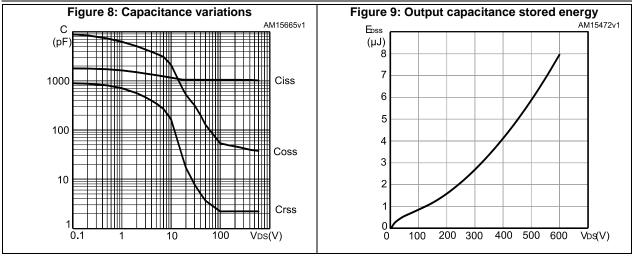
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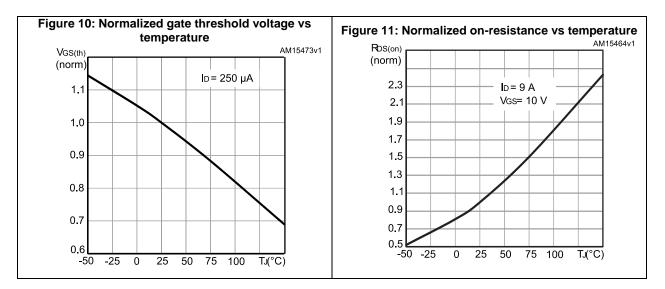


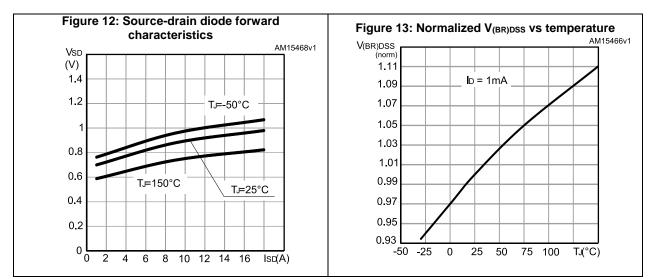
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Electrical characteristics

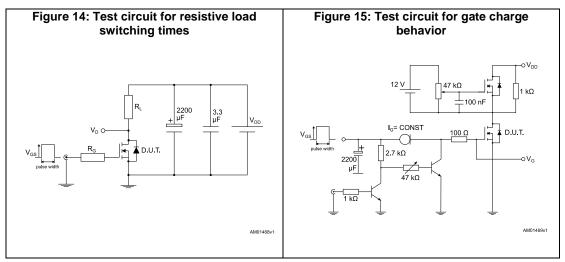


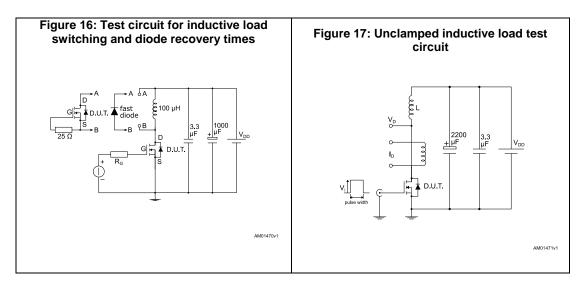


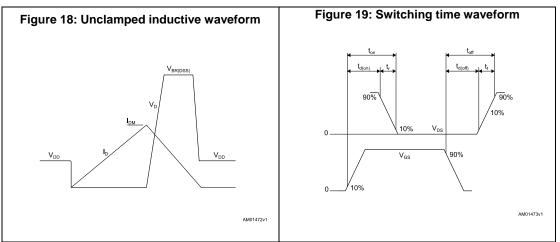


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3 Test circuits









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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-220FP wide creepage package information

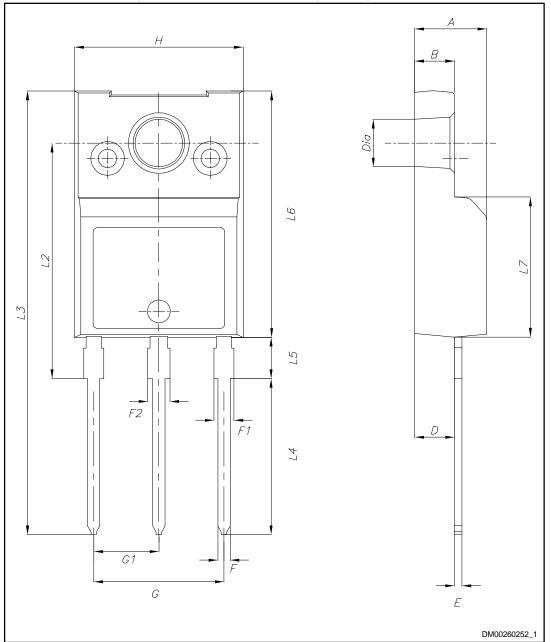


Figure 20: TO-220FP wide creepage package outline

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Package information

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9: TO-220FP wide cree	page package mechanica	al data				
	Table 9: TO-220FP wide creepage package mechanical data					
	mm					
Min.	Тур.	Max.				
4.60	4.70	4.80				
2.50	2.60	2.70				
2.49	2.59	2.69				
0.46		0.59				
0.76		0.89				
0.96		1.25				
1.11		1.40				
8.40	8.50	8.60				
4.15	4.25	4.35				
10.90	11.00	11.10				
15.25	15.40	15.55				
28.70	29.00	29.30				
10.00	10.20	10.40				
2.55	2.70	2.85				
16.00	16.10	16.20				
9.05	9.15	9.25				
3.00	3.10	3.20				
	4.60 2.50 2.49 0.46 0.76 0.96 1.11 8.40 4.15 10.90 15.25 28.70 10.00 2.55 16.00 9.05	Min.Typ.4.604.702.502.602.492.590.460.760.961.118.408.504.154.2510.9011.0015.2515.4028.7029.0010.0010.202.552.7016.0016.109.059.15				



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
07-Jun-2016	1	First release.
16-Jun-2016	2	Document status promoted from preliminary data to production data. Minor text changes.



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